

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L21	6966	mold and frame and die and light	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/16 12:56
L22	168	I2 and (ic or (integrated adj circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/16 12:57